

Carrier Material Report for MSP430F5510IPT

Tray Information:

	KO									
$\begin{vmatrix} + + + + \\ + + + \end{vmatrix}$	+ + + + + + + + + + + +	+ + + + + + + + +	+ + + + + + + + + + + + + + + + + + +	+ + + + + + + +	+ + + + + + + + + + + + + + + + + + +	W - Outer utray Width				
P1 - Tray unit pocket pitch CW - Measurement for tray edge (Y direction) to corner pocket center CL - Measurement for tray edge (X direction) to corner pocket center										

Device	Package	Package	Pins	SPQ	Unit	Max	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW
	Drawing	Туре			Array	Temp						(mm)
					Matrix	(°C)						
MSP4	PT	LQFP	48	250	10 x 25	150	315	135.9	7620	12.2	11.1	11.25
30F55												
10IPT												

Images above are just a representation of the carrier. Actual carrier may vary. Please reference the dimensions provided in the table.

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